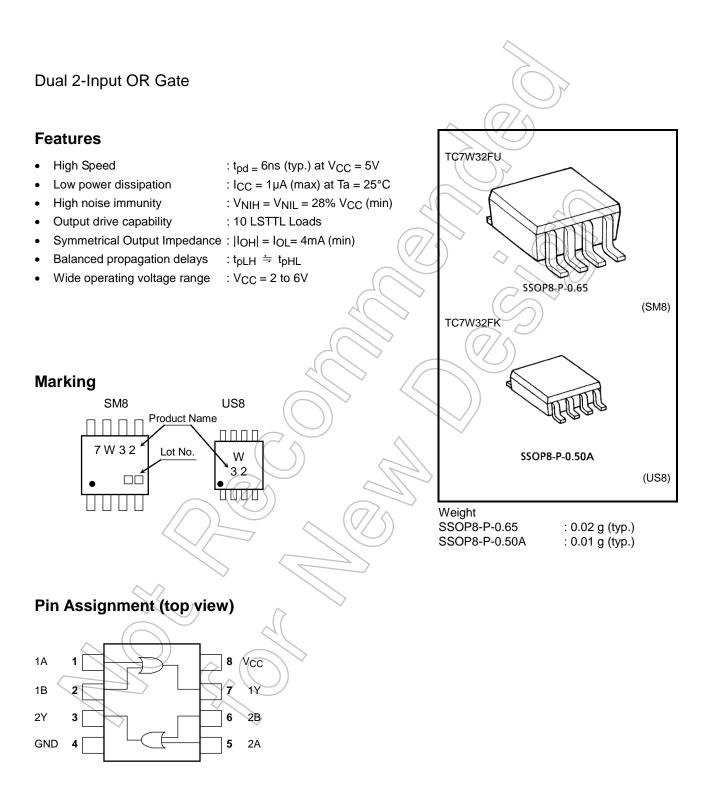
TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7W32FU, TC7W32FK



Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Supply voltage	V _{CC}	-0.5 to 7.0	V	
DC input voltage	V _{IN}	–0.5 to V _{CC} + 0.5	V	
DC output voltage	V _{OUT} -0.5 to V _{CC} + 0.5		V	
Input diode current		±20		
Output diode current	I _{OK}	±20	mA	
DC output current	Ιουτ	±25	mA	
DC V _{CC} /ground current	ICC	±25	mA	
Power dissipation	5	300 (SM8)		
	P _D	200 (US8)	mW	
Storage temperature	T _{stg}	-65 to 150	°C	
Lead temperature (10 s)	TL	260	°C 🔍	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

IEC Logic Symbol

Truth Table

IN A		А	в
IN B	≥1	L	L
l		L H	
		H	н

Operating Ranges

Characteristics	Symbol	Rating	Unit
Supply voltage	Vcc	2.0 to 6.0	V
Input voltage	VIN	0 to V _{CC}	V
Output voltage	Vout	0 to V _{CC}	V
Operating temperature	Topr	-40 to 85	°C
		0 to 1000 ($V_{CC} = 2.0 V$)	
Input rise and fall time	t _r , t _f	0 to 500 $(V_{CC} = 4.5 V)$	ns
		0 to 400 $(V_{CC} = 6.0 \text{ V})$	

Electrical Characteristics

DC Characteristics

			Ta = 25°C			Ta = -40	ا ا م			
Characteristics	Symbol	nbol Test Condition		V _{CC} (V)	Min	Тур.	Max	Min	Max	Unit
				2.0	1.5	_	\mathcal{A}	1.5	_	
High-level input voltage	VIH		_	4.5	3.15	_	ĺ	3.15	_	
				6.0	4.2		Å	4.2		N/
				2.0		-(0.5		0.5	V
Low-level input voltage	VIL		_	4.5	_ <	$) \rightarrow /$	1.35	—	1.35	
				6.0	_	$\langle \frown \rangle$	1.8	—	1.8	
	V _{OH} V	V _{IN} = V _{IH} or V _{IL}		2.0	1.9	2.0	$)^{\prime}-$	1.9	—	
			I _{OH} = -20 μA	4.5	4.4	4.5	_	4.4	/	
High-level output voltage				6.0	5.9	6.0	_	5.9	K	
			I _{OH} = -4 mA	4.5	4.18	4.31	- (4.13	$\geq -$	
			I _{OH} = -5.2 mA	6.0	5.68	5.80 <		5.63) -	V
Low-level output voltage	V _{OL} V _{IN} = V _{IL}			2.0		0.0	0.1	F	0.1	v
			I _{OL} = 20 μA	4.5	>	0.0	0.1	<u> </u>	0.1	
		$V_{IN} = V_{IL}$		6.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 4 \text{ mA}$	4.5	_	0.17	0.26	_	0.33	
		I _{OL} = 5.2 mA	6.0		0.18	0.26		0.33		
Input leakage current	I _{IN}	$V_{IN} = V_{CC} \text{ or GND}$		6.0 <	<-	\rightarrow	±.0.1	_	±1.0	μA
Quiescent supply current	ICC	$V_{IN} = V_{CC}$	or GND	6.0	X	H	1.0	_	10.0	μA

AC Characteristics (C_L = 15pF, V_{CC} = 5V, Ta = 25°C)

Characteristics	Quarter	Test Cas dition	-	Linit		
	Symbol	Test Condition	Min	Тур.	Max	Unit
Output Transition Time	t _{TLH} t _{THL}	_		4	8	ns
Propagation Delay Time	t _{pLH} t _{pHL}	_		6	12	ns

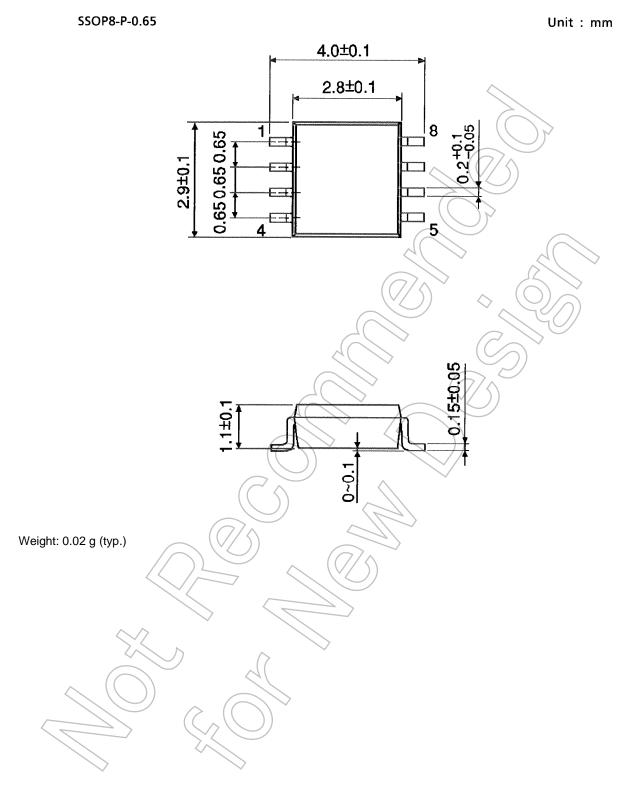
AC Characteristics (C_L = 50pF, Input: $t_r = t_f = 6$ ns)

					$\langle \frown \rangle$				
Characteristics	Quarter	Test Condition		Ta = 25°C		Ta = -40 to 85°C		Unit	
	Symbol	Test Condition	V _{CC} (V)	Min	Тур.	Max	Min	Max	Unit
Output Transition Time	^t тLH t _{THL}	_	2.0	4	25	75	A	95	ns
			4.5		> 7	15	$\leq \sim$	19	
		6.0	$\langle - \rangle$	6 <	13	\mathcal{D}	16		
Propagation delay time	^t pLH		2.0		27	75	TH)	95	
		—	4.5	\geq	8	15	≥ 1	19	ns
		6.0		7	13)	—	16		
Input capacitance	C _{IN}	-(_	\sim	_	(57)	10	—	10	pF
Power dissipation capacitance	C _{PD}		(Note 1)		21	<u> </u>	—	—	pF

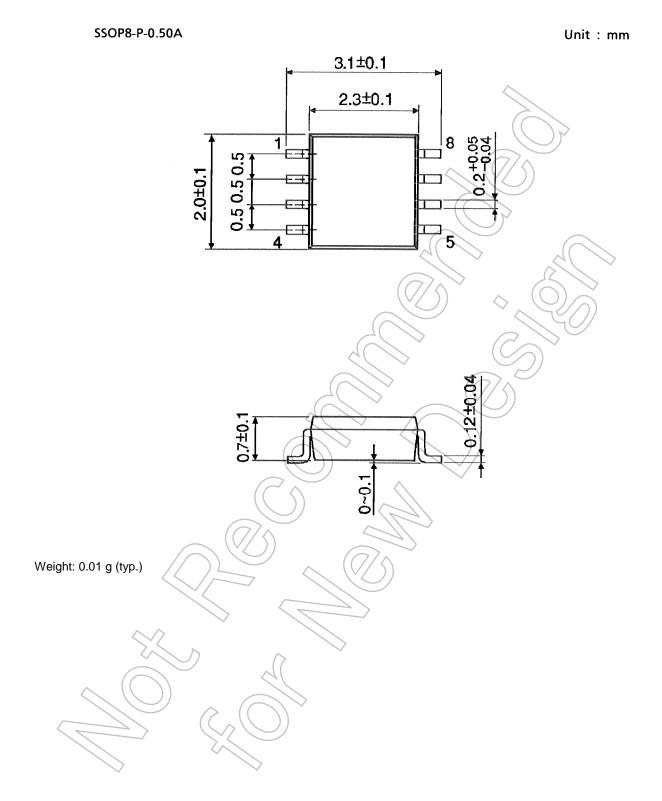
Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:

 $I_{CC (opr.)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2$

Package Dimensions



Package Dimensions



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